

### Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <a href="http://www.nxp.com">http://www.nxp.com</a>, <a href="http://www.semiconductors.philips.com/">http://www.nxp.com</a>, <a href="http://www.nexperia.com">http://www.nexperia.com</a>, <a href="http://www.nexperia.com">http://www.nexperia.com</a>)

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

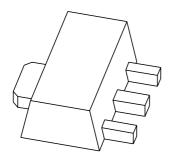
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

# **DISCRETE SEMICONDUCTORS**

# DATA SHEET



PBSS5480X 80 V, 4 A PNP low V<sub>CEsat</sub> (BISS) transistor

Product data sheet Supersedes data of 2004 Jun 8 2004 Nov 08



# 80 V, 4 A PNP low V<sub>CEsat</sub> (BISS) transistor

## **PBSS5480X**

#### **FEATURES**

- High h<sub>FE</sub> and low V<sub>CEsat</sub> at high current operation
- High collector current I<sub>C</sub>: 4 A
- High efficiency leading to less heat generation.

### **APPLICATIONS**

- Medium power peripheral drivers (e.g. fans and motors)
- Strobe flash units for digital still cameras and mobile phones
- Inverter applications (e.g. TFT displays)
- · Power switch for LAN and ADSL systems
- Medium power DC-to-DC conversion
- · Battery chargers.

### **DESCRIPTION**

PNP low V<sub>CEsat</sub> (BISS) transistor in a SOT89 (SC-62) plastic package.

NPN complement: PBSS4480X.

### **MARKING**

TYPE NUMBER	MARKING CODE(1)
PBSS5480X	*1Z

### Note

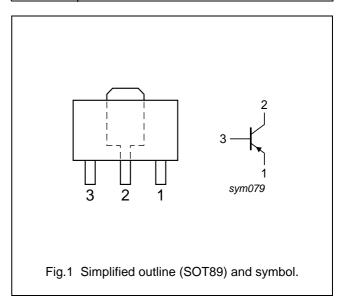
- 1. \* = p: made in Hong Kong.
  - \* = t: made in Malaysia.
  - \* = W: made in China.

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	-80	V
I <sub>C</sub>	collector current (DC)	-4	Α
I <sub>CM</sub>	peak collector current	-10	Α
R <sub>CEsat</sub>	equivalent on-resistance 75 mg		mΩ

### **PINNING**

PIN	DESCRIPTION
1	emitter
2	collector
3	base



## **ORDERING INFORMATION**

TYPE NUMBER		PACKAGE	
TIPE NOWIBER	NAME DESCRIPTION		VERSION
PBSS5480X	SC-62	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads	

# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5480X

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

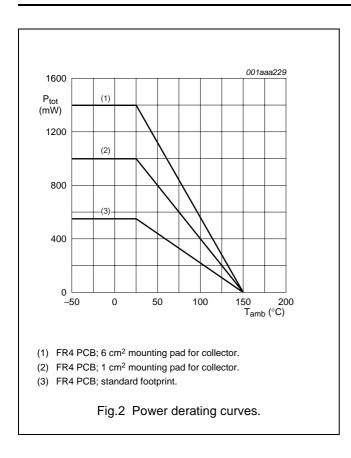
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-80	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-80	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V
Ic	collector current (DC)	note 1	_	-4	Α
I <sub>CM</sub>	peak collector current	$t_p \le 1$ ms or limited by $T_{j(max)}$	_	-10	Α
I <sub>CRP</sub>	repetitive peak collector current	$t_p \le 10 \text{ ms};  \delta \le 0.1$	_	-6	Α
I <sub>B</sub>	base current (DC)		_	-1	Α
I <sub>BM</sub>	peak base current	$t_p \le 1 \text{ ms}$	_	-2	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C			
		notes 2 and 3	_	2.5	W
		note 3	_	0.55	W
		note 4	_	1	W
		note 1	_	1.4	W
		note 5	_	1.6	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

### **Notes**

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- 2. Operated under pulsed conditions; pulse width  $t_p \leq 10$  ms; duty cycle  $\delta \leq 0.1$ .
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated, standard footprint.
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- 5. Device mounted on a 7 cm<sup>2</sup> ceramic printed-circuit board, 1 cm<sup>2</sup> single-sided copper, tin-plated.

# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5480X



# 80 V, 4 A PNP low V<sub>CEsat</sub> (BISS) transistor

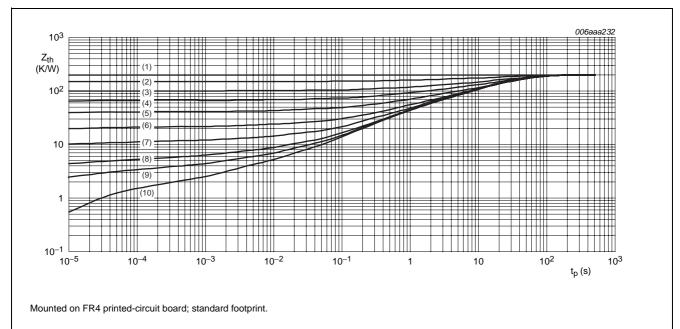
PBSS5480X

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air		
		notes 1 and 2	50	K/W
		note 2	225	K/W
		note 3	125	K/W
		note 4	90	K/W
		note 5	80	K/W
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		16	K/W

#### **Notes**

- 1. Operated under pulsed conditions; pulse width  $t_p \le 10$  ms; duty cycle  $\delta \le 0.2$ .
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated, standard footprint.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- 5. Device mounted on a 7 cm<sup>2</sup> ceramic printed-circuit board, 1 cm<sup>2</sup> single-sided copper, tin-plated.



- (1)  $\delta = 1$ .
- (3)  $\delta = 0.5$ .
- (5)  $\delta = 0.2$ .
- (7)  $\delta = 0.05$ .
- (9)  $\delta = 0.01$ .

- (2)  $\delta = 0.75$ .
- (4)  $\delta = 0.33$ .
- (6)  $\delta = 0.1$ .
- (8)  $\delta = 0.02$ .
- (10)  $\delta = 0$ .

Fig.3 Transient thermal impedance as a function of pulse time; typical values.

# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5480X

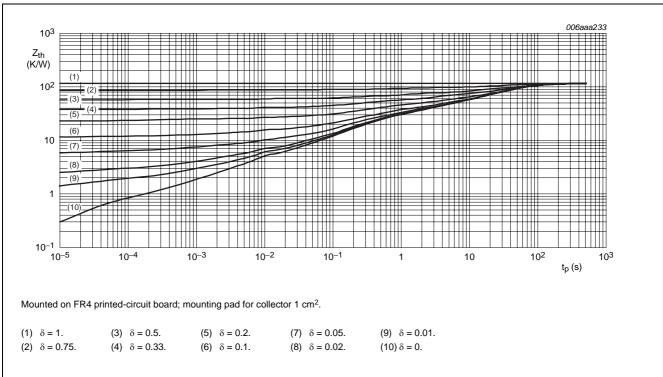
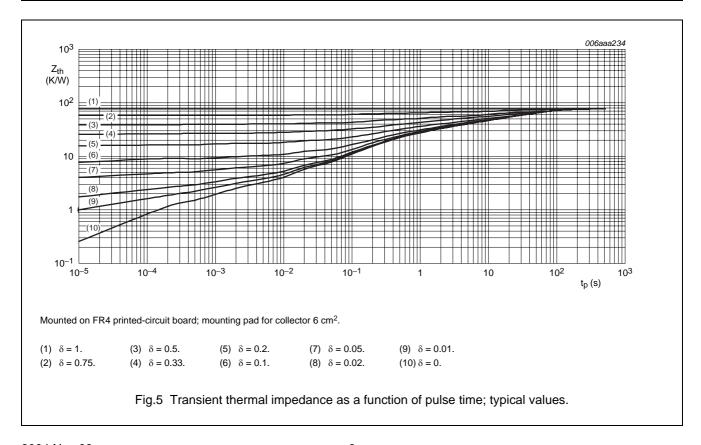


Fig.4 Transient thermal impedance as a function of pulse time; typical values.



# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

PBSS5480X

## **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}$	_	_	-100	nA
		$V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = -60 \text{ V}; V_{BE} = 0 \text{ V}$	_	_	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	_	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -0.5 \text{ A}$	200	300	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	180	280	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	150	240	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -4 \text{ A}; \text{ note 1}$	80	150	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}$	_	-35	<b>-55</b>	mV
		$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	-70	-105	mV
		$I_C = -2 \text{ A}; I_B = -40 \text{ mA}$	_	-170	-250	mV
		$I_C = -4 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	-220	-340	mV
		$I_C = -5 \text{ A}; I_B = -500 \text{ mA}; \text{ note 1}$	_	-250	-380	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = -5 \text{ A}$ ; $I_B = -500 \text{ mA}$ ; note 1	_	50	75	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}$	_	-770	-850	mV
		$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	-810	-900	mV
		$I_C = -1 \text{ A}; I_B = -100 \text{ mA}; \text{ note } 1$	_	-810	-900	mV
		$I_C = -4 \text{ A}$ ; $I_B = -400 \text{ mA}$ ; note 1	_	-930	-1000	mV
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}$	_	-760	-850	mV
f <sub>T</sub>	transition frequency	$I_C = -0.1 \text{ A}; V_{CE} = -10 \text{ V};$ f = 100 MHz	100	125	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	_	60	90	pF

## Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

## PBSS5480X

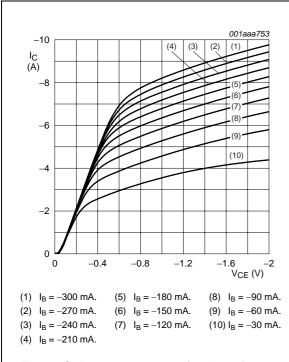
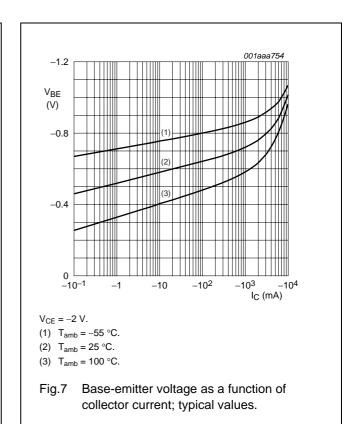


Fig.6 Collector current as a function of collector-emitter voltage; typical values.



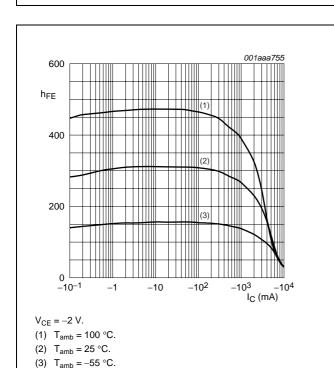
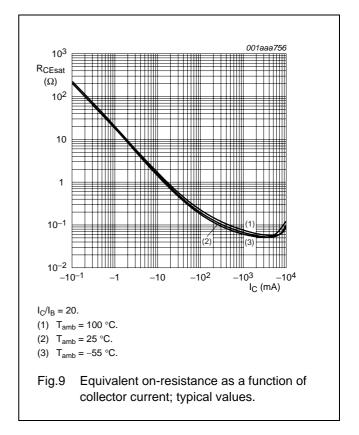
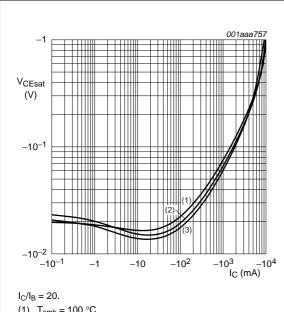


Fig.8 DC current gain as a function of collector current; typical values.



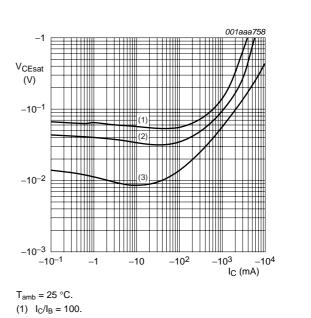
# 80 V, 4 A PNP low V<sub>CEsat</sub> (BISS) transistor

## PBSS5480X



- (1)  $T_{amb} = 100 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

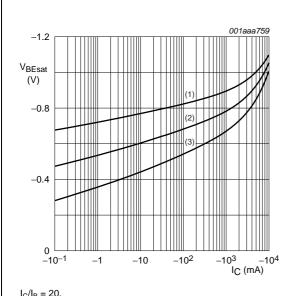
Fig.10 Collector-emitter saturation voltage as a function of collector current; typical values.



(2)  $I_C/I_B = 50$ .

(3)  $I_C/I_B = 10$ .

Fig.11 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B}=20.$ 

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 100 \, ^{\circ}C$ .

Fig.12 Base-emitter saturation voltage as a function of collector current; typical values.

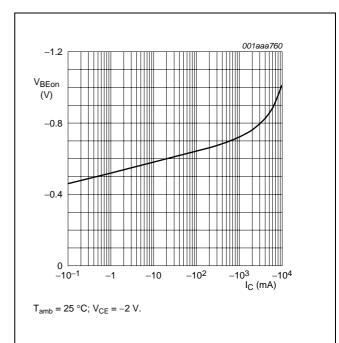


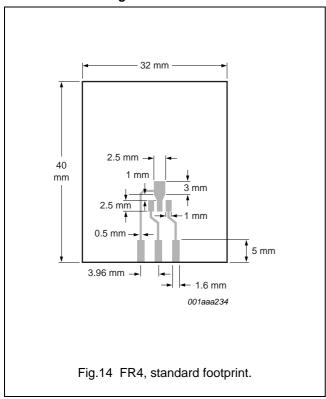
Fig.13 Base-emitter turn-on voltage as a function of collector current; typical values.

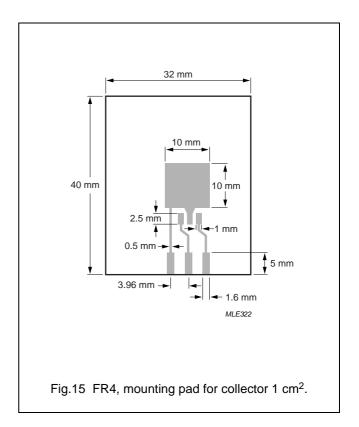
2004 Nov 08 9

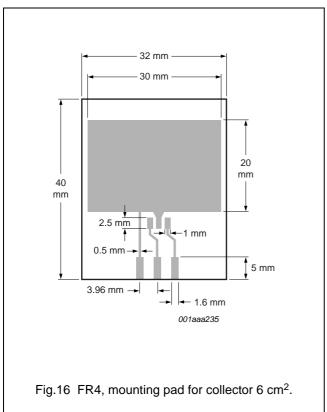
# 80 V, 4 A PNP low $V_{CEsat}$ (BISS) transistor

## PBSS5480X

## Reference mounting conditions







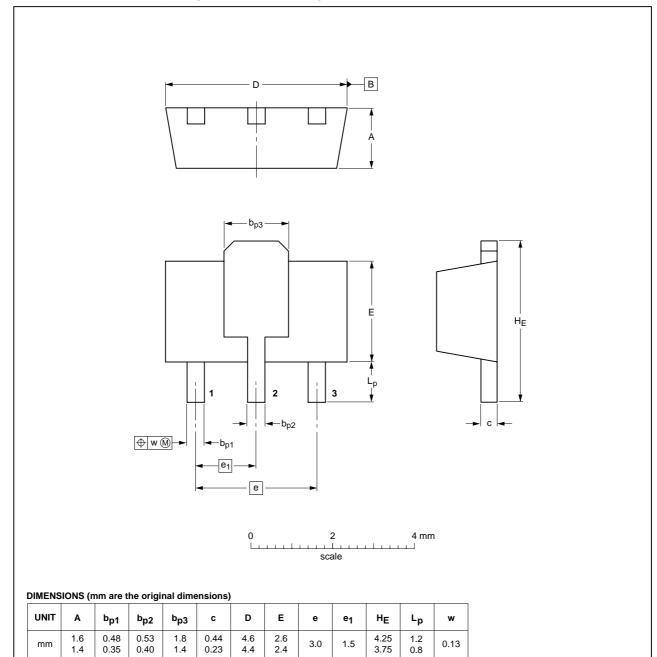
80 V, 4 A PNP low  $V_{CEsat}$  (BISS) transistor

PBSS5480X

## **PACKAGE OUTLINE**

## Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	OUTLINE REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT89		TO-243	SC-62			<del>04-08-03</del> 06-03-16

# 80 V, 4 A PNP low V<sub>CEsat</sub> (BISS) transistor

PBSS5480X

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### **Notes**

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published
  and may differ in case of multiple devices. The latest product status information is available on the Internet at
  URL http://www.nxp.com.

#### **DISCLAIMERS**

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions

above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

# **NXP Semiconductors**

## **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

### **Contact information**

For additional information please visit: http://www.nxp.com
For sales offices addresses send e-mail to: salesaddresses@nxp.com

© NXP B.V. 2009

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

 Printed in The Netherlands
 R75/02/pp13
 Date of release: 2004 Nov 08
 Document order number: 9397 750 13891



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bipolar Transistors - BJT category:

Click to view products by Nexperia manufacturer:

Other Similar products are found below:

BC559C MCH4017-TL-H MMBT-2369-TR BC546/116 NJVMJD148T4G NTE16 NTE195A IMX9T110 2N4401-A 2N6728 2SA1419T-TD-H 2SB1204S-TL-E 2SC5488A-TL-H FMC5AT148 2N2369ADCSM 2N2907A 2N3904-NS 2N5769 2SC4618TLN CPH6501-TL-E US6T6TR BAX18/A52R BC556/112 IMZ2AT108 MMST8098T146 MCH6102-TL-E BC846B-13-F 2N3879 30A02MH-TL-E NTE13 NTE282 NTE323 NTE350 NTE81 JANTX2N2920L JANSR2N2907AUB CMLT3946EG TR SNSS40600CF8T1G CMLT3906EG TR GRP-DATA-JANS2N2907AUB GRP-DATA-JANS2N2222AUA MMDT3946FL3-7 2N4240 JANS2N3019 MSB30KH-13 2N2221AUB 2SD1815T-TL-E 2N6678 2N2907Ae4 JAN2N3507